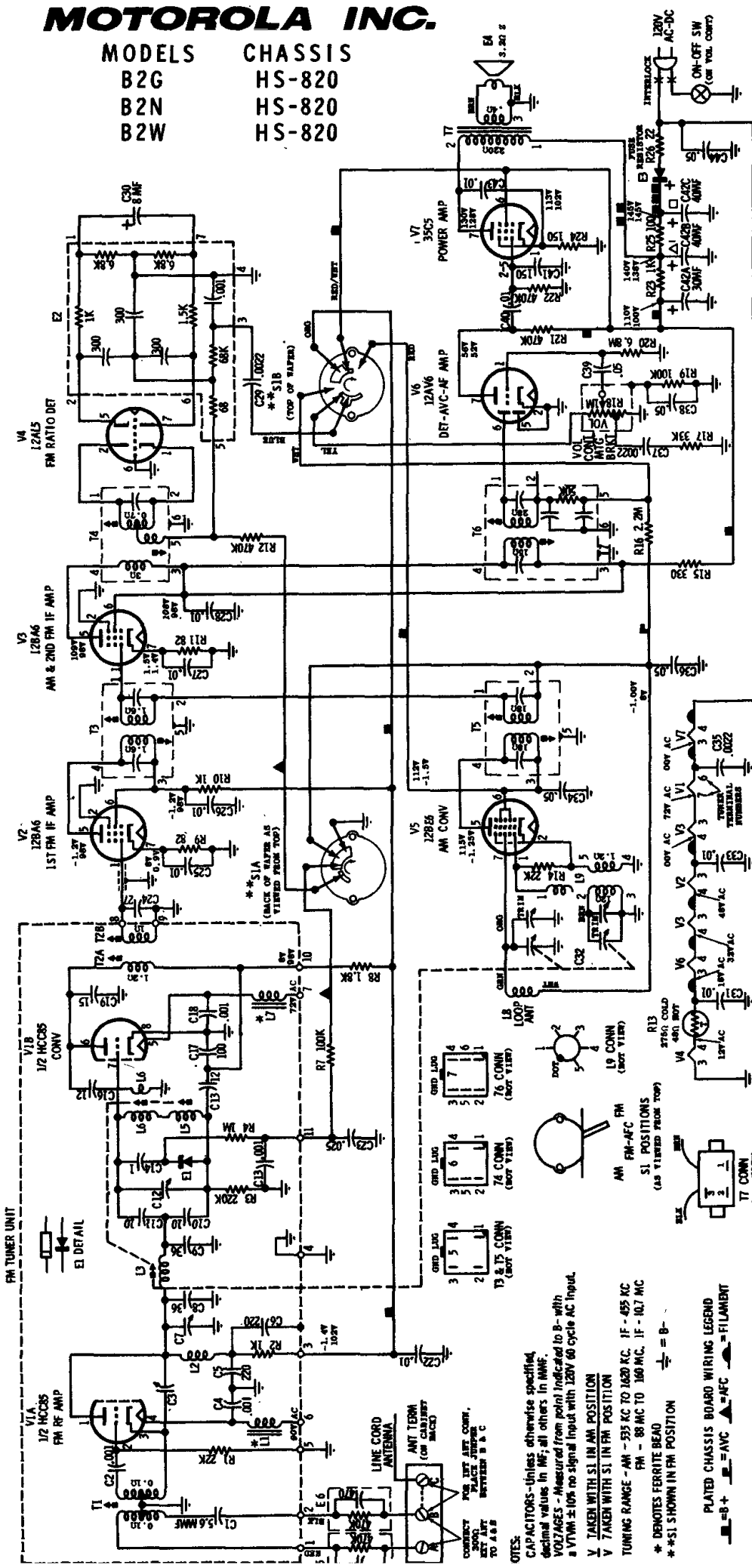


MOTOROLA INC.

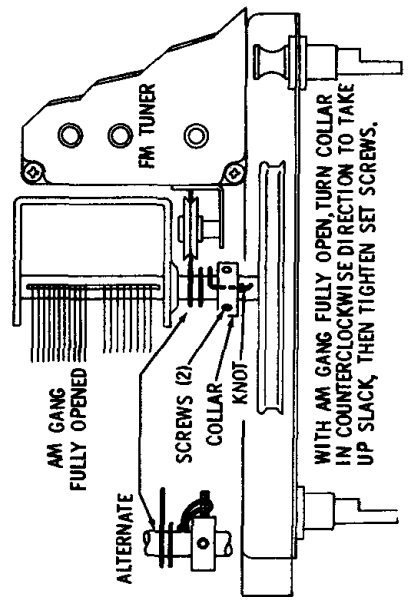
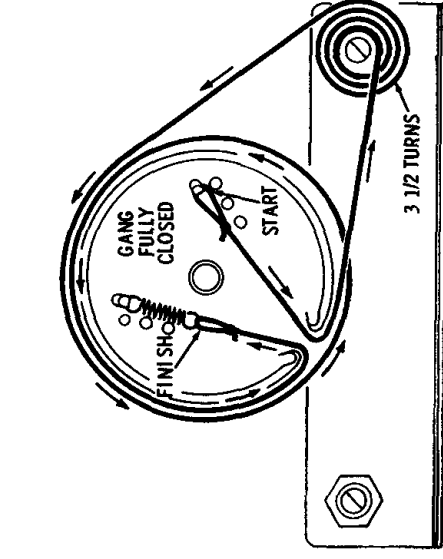
| MODELS | CHASSIS |
|--------|---------|
| B2G | HS-820 |
| B2N | HS-820 |
| B2W | HS-820 |



All plated circuit wiring is on bottom of board. The top side is for ground shielding only. No circuits are carried through holes and across the board underneath components. The plated chassis board wiring diagram is shown as viewed from bottom (wiring) side.

TO REMOVE CHASSIS FROM CABINET

1. Remove control knobs - pull straight off.
2. Remove 4 screws holding cabinet back to cabinet.
3. Remove 2 screws holding chassis support channel.
4. Remove 1 screw holding drive pulley bracket to inside front of cabinet.
5. Unsolder speaker leads.
6. Remove chassis from cabinet.



DIAL STRINGING DETAIL

PLATED CHASSIS BOARD

PLATED CHASSIS BOARD WIRING LEGEND

—B+ —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT

—B- —AFC —FILAMENT